

# MC74VHC240

## Octal Bus Buffer/Line Driver Inverting with 3-State Outputs

The MC74VHC240 is an advanced high speed CMOS octal bus buffer fabricated with silicon gate CMOS technology. It achieves high speed operation similar to equivalent Bipolar Schottky TTL while maintaining CMOS low power dissipation.

The MC74VHC240 is an inverting 3-state buffer, and has two active-low output enables. This device is designed to drive bus lines or buffer memory address registers.

The internal circuit is composed of three stages, including a buffer output which provides high noise immunity and stable output. The inputs tolerate voltages up to 7V, allowing the interface of 5V systems to 3V systems.

- High Speed:  $t_{PD} = 3.6 \text{ ns}$  (Typ) at  $V_{CC} = 5 \text{ V}$
- Low Power Dissipation:  $I_{CC} = 4 \mu\text{A}$  (Max) at  $T_A = 25^\circ\text{C}$
- High Noise Immunity:  $V_{NIH} = V_{NIL} = 28\% V_{CC}$
- Power Down Protection Provided on Inputs
- Balanced Propagation Delays
- Designed for 2 V to 5.5 V Operating Range
- Low Noise:  $V_{OLP} = 0.9 \text{ V}$  (Max)
- Pin and Function Compatible with Other Standard Logic Families
- Latchup Performance Exceeds 300 mA
- ESD Performance: HBM > 2000 V; Machine Model > 200 V
- Chip Complexity: 120 FETs or 30 Equivalent Gates
- These Devices are Pb-Free and are RoHS Compliant

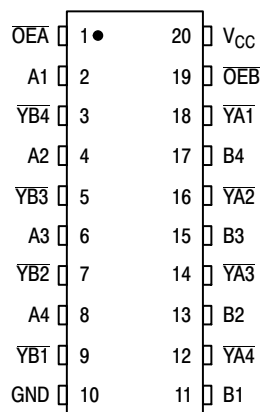


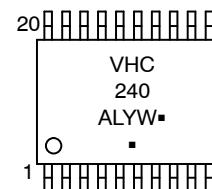
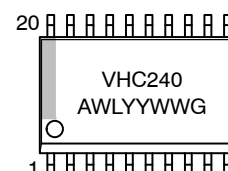
Figure 1. Pin Assignment



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### MARKING DIAGRAMS



VHC240 = Specific Device Code  
A = Assembly Location  
WL, L = Wafer Lot  
Y = Year  
WW, W = Work Week  
G or ■ = Pb-Free Package

(Note: Microdot may be in either location)

### ORDERING INFORMATION

| Device          | Package  | Shipping†       |
|-----------------|----------|-----------------|
| MC74VHC240DWR2G | SOIC-20  | 1000 Units/Reel |
| MC74VHC240DTR2G | TSSOP-20 | 2500 Units/Reel |

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

### FUNCTION TABLE

| INPUTS   |      | OUTPUTS |
|----------|------|---------|
| OEA, OEB | A, B | YA, YB  |
| L        | L    | H       |
| L        | H    | L       |
| H        | X    | Z       |

# MC74VHC240

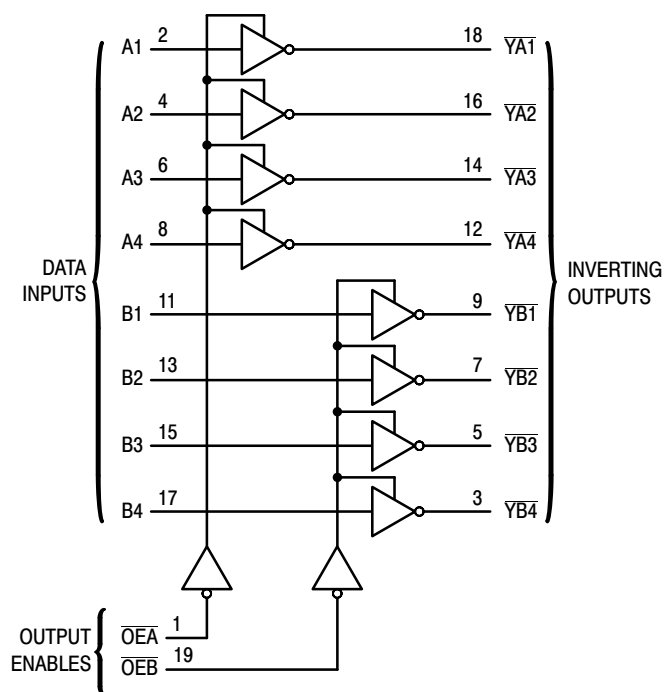


Figure 1. LOGIC DIAGRAM

## MAXIMUM RATINGS\*

| Symbol    | Parameter                                                        | Value                   | Unit |
|-----------|------------------------------------------------------------------|-------------------------|------|
| $V_{CC}$  | DC Supply Voltage                                                | - 0.5 to + 7.0          | V    |
| $V_{in}$  | DC Input Voltage                                                 | - 0.5 to + 7.0          | V    |
| $V_{out}$ | DC Output Voltage                                                | - 0.5 to $V_{CC} + 0.5$ | V    |
| $I_{IK}$  | Input Diode Current                                              | - 20                    | mA   |
| $I_{OK}$  | Output Diode Current                                             | $\pm 20$                | mA   |
| $I_{out}$ | DC Output Current, per Pin                                       | $\pm 25$                | mA   |
| $I_{CC}$  | DC Supply Current, $V_{CC}$ and GND Pins                         | $\pm 75$                | mA   |
| $P_D$     | Power Dissipation in Still Air, SOIC Packages†<br>TSSOP Package† | 500<br>450              | mW   |
| $T_{stg}$ | Storage Temperature                                              | - 65 to + 150           | °C   |

\* Absolute maximum continuous ratings are those values beyond which damage to the device may occur. Exposure to these conditions or conditions beyond those indicated may adversely affect device reliability. Functional operation under absolute-maximum-rated conditions is not implied.

† Derating — SOIC Packages: - 7 mW/°C from 65° to 125°C  
TSSOP Package: - 6.1 mW/°C from 65° to 125°C

## RECOMMENDED OPERATING CONDITIONS

| Symbol     | Parameter                                                                        | Min    | Max       | Unit |
|------------|----------------------------------------------------------------------------------|--------|-----------|------|
| $V_{CC}$   | DC Supply Voltage                                                                | 2.0    | 5.5       | V    |
| $V_{in}$   | DC Input Voltage                                                                 | 0      | 5.5       | V    |
| $V_{out}$  | DC Output Voltage                                                                | 0      | $V_{CC}$  | V    |
| $T_A$      | Operating Temperature, All Package Types                                         | - 40   | + 85      | °C   |
| $t_r, t_f$ | Input Rise and Fall Time<br>$V_{CC} = 3.3V \pm 0.3V$<br>$V_{CC} = 5.0V \pm 0.5V$ | 0<br>0 | 100<br>20 | ns/V |

This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high-impedance circuit. For proper operation,  $V_{in}$  and  $V_{out}$  should be constrained to the range  $GND \leq (V_{in} \text{ or } V_{out}) \leq V_{CC}$ .

Unused inputs must always be tied to an appropriate logic voltage level (e.g., either GND or  $V_{CC}$ ). Unused outputs must be left open.

# MC74VHC240

## DC ELECTRICAL CHARACTERISTICS

| Symbol          | Parameter                           | Test Conditions                                                                                            | V <sub>CC</sub><br>V | T <sub>A</sub> = 25°C         |                   |                               | T <sub>A</sub> = - 40 to 85°C |                               | Unit |
|-----------------|-------------------------------------|------------------------------------------------------------------------------------------------------------|----------------------|-------------------------------|-------------------|-------------------------------|-------------------------------|-------------------------------|------|
|                 |                                     |                                                                                                            |                      | Min                           | Typ               | Max                           | Min                           | Max                           |      |
| V <sub>IH</sub> | Minimum High-Level Input Voltage    |                                                                                                            | 2.0<br>3.0 to 5.5    | 1.50<br>V <sub>CC</sub> × 0.7 |                   |                               | 1.50<br>V <sub>CC</sub> × 0.7 |                               | V    |
| V <sub>IL</sub> | Maximum Low-Level Input Voltage     |                                                                                                            | 2.0<br>3.0 to 5.5    |                               |                   | 0.50<br>V <sub>CC</sub> × 0.3 |                               | 0.50<br>V <sub>CC</sub> × 0.3 | V    |
| V <sub>OH</sub> | Minimum High-Level Output Voltage   | V <sub>in</sub> = V <sub>IH</sub> or V <sub>IL</sub><br>I <sub>OH</sub> = - 50μA                           | 2.0<br>3.0<br>4.5    | 1.9<br>2.9<br>4.4             | 2.0<br>3.0<br>4.5 |                               | 1.9<br>2.9<br>4.4             |                               | V    |
|                 |                                     | V <sub>in</sub> = V <sub>IH</sub> or V <sub>IL</sub><br>I <sub>OH</sub> = - 4mA<br>I <sub>OH</sub> = - 8mA | 3.0<br>4.5           | 2.58<br>3.94                  |                   |                               | 2.48<br>3.80                  |                               |      |
| V <sub>OL</sub> | Maximum Low-Level Output Voltage    | V <sub>in</sub> = V <sub>IH</sub> or V <sub>IL</sub><br>I <sub>OL</sub> = 50μA                             | 2.0<br>3.0<br>4.5    |                               | 0.0<br>0.0<br>0.0 | 0.1<br>0.1<br>0.1             |                               | 0.1<br>0.1<br>0.1             | V    |
|                 |                                     | V <sub>in</sub> = V <sub>IH</sub> or V <sub>IL</sub><br>I <sub>OL</sub> = 4mA<br>I <sub>OL</sub> = 8mA     | 3.0<br>4.5           |                               |                   | 0.36<br>0.36                  |                               | 0.44<br>0.44                  |      |
| I <sub>in</sub> | Maximum Input Leakage Current       | V <sub>in</sub> = 5.5V or GND                                                                              | 0 to 5.5             |                               |                   | ± 0.1                         |                               | ± 1.0                         | μA   |
| I <sub>OZ</sub> | Maximum Three-State Leakage Current | V <sub>in</sub> = V <sub>IL</sub> or V <sub>IH</sub><br>V <sub>out</sub> = V <sub>CC</sub> or GND          | 5.5                  |                               |                   | ± 0.25                        |                               | ± 2.5                         | μA   |
| I <sub>CC</sub> | Maximum Quiescent Supply Current    | V <sub>in</sub> = V <sub>CC</sub> or GND                                                                   | 5.5                  |                               |                   | 4.0                           |                               | 40.0                          | μA   |

# MC74VHC240

## AC ELECTRICAL CHARACTERISTICS (Input $t_r = t_f = 3.0\text{ns}$ )

| Symbol                     | Parameter                                                                                                               | Test Conditions                                                 | $T_A = 25^\circ\text{C}$ |      |      | $T_A = -40 \text{ to } 85^\circ\text{C}$ |      | Unit |
|----------------------------|-------------------------------------------------------------------------------------------------------------------------|-----------------------------------------------------------------|--------------------------|------|------|------------------------------------------|------|------|
|                            |                                                                                                                         |                                                                 | Min                      | Typ  | Max  | Min                                      | Max  |      |
| $t_{PLH}$ ,<br>$t_{PHL}$   | Maximum Propagation Delay,<br>A to $\overline{YA}$ or B to $\overline{YB}$                                              | $V_{CC} = 3.3 \pm 0.3\text{V}$ $C_L = 15\text{pF}$              |                          | 5.3  | 7.5  | 1.0                                      | 9.0  | ns   |
|                            |                                                                                                                         | $C_L = 50\text{pF}$                                             |                          | 7.8  | 11.0 | 1.0                                      | 12.5 |      |
|                            |                                                                                                                         | $V_{CC} = 5.0 \pm 0.5\text{V}$ $C_L = 15\text{pF}$              |                          | 3.6  | 5.5  | 1.0                                      | 6.5  |      |
|                            |                                                                                                                         | $C_L = 50\text{pF}$                                             |                          | 5.1  | 7.5  | 1.0                                      | 8.5  |      |
| $t_{PZL}$ ,<br>$t_{PZH}$   | Output Enable Time<br>$\overline{OE\overline{A}}$ to $\overline{YA}$ or $\overline{OE\overline{B}}$ to $\overline{YB}$  | $V_{CC} = 3.3 \pm 0.3\text{V}$ $C_L = 15\text{pF}$              |                          | 6.6  | 10.6 | 1.0                                      | 12.5 | ns   |
|                            |                                                                                                                         | $R_L = 1\text{k}\Omega$ $C_L = 50\text{pF}$                     |                          | 9.1  | 14.1 | 1.0                                      | 16.0 |      |
|                            |                                                                                                                         | $V_{CC} = 5.0 \pm 0.5\text{V}$ $C_L = 15\text{pF}$              |                          | 4.7  | 7.3  | 1.0                                      | 8.5  |      |
|                            |                                                                                                                         | $R_L = 1\text{k}\Omega$ $C_L = 50\text{pF}$                     |                          | 6.2  | 9.3  | 1.0                                      | 10.5 |      |
| $t_{PLZ}$ ,<br>$t_{PHZ}$   | Output Disable Time<br>$\overline{OE\overline{A}}$ to $\overline{YA}$ or $\overline{OE\overline{B}}$ to $\overline{YB}$ | $V_{CC} = 3.3 \pm 0.3\text{V}$ $C_L = 50\text{pF}$              |                          | 10.3 | 14.0 | 1.0                                      | 16.0 | ns   |
|                            |                                                                                                                         | $R_L = 1\text{k}\Omega$                                         |                          |      |      |                                          |      |      |
|                            |                                                                                                                         | $V_{CC} = 5.0 \pm 0.5\text{V}$ $C_L = 50\text{pF}$              |                          | 6.7  | 9.2  | 1.0                                      | 10.5 |      |
|                            |                                                                                                                         | $R_L = 1\text{k}\Omega$                                         |                          |      |      |                                          |      |      |
| $t_{OSLH}$ ,<br>$t_{OSHL}$ | Output to Output Skew                                                                                                   | $V_{CC} = 3.3 \pm 0.3\text{V}$ $C_L = 50\text{pF}$<br>(Note 1.) |                          |      | 1.5  |                                          | 1.5  | ns   |
|                            |                                                                                                                         | $V_{CC} = 5.0 \pm 0.5\text{V}$ $C_L = 50\text{pF}$<br>(Note 1.) |                          |      | 1.0  |                                          | 1.0  |      |
| $C_{in}$                   | Maximum Input Capacitance                                                                                               |                                                                 |                          | 4    | 10   |                                          | 10   | pF   |
| $C_{out}$                  | Maximum Three-State Output Capacitance (Output in High-Impedance State)                                                 |                                                                 |                          | 6    |      |                                          |      | pF   |

|          |                                         |                                                       |    |
|----------|-----------------------------------------|-------------------------------------------------------|----|
| $C_{PD}$ | Power Dissipation Capacitance (Note 2.) | Typical @ $25^\circ\text{C}$ , $V_{CC} = 5.0\text{V}$ | pF |
|          |                                         | 17                                                    |    |

- Parameter guaranteed by design.  $t_{OSLH} = |t_{PLHm} - t_{PLHn}|$ ,  $t_{OSHL} = |t_{PHLm} - t_{PHLn}|$ .
- $C_{PD}$  is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation:  $I_{CC(OPR)} = C_{PD} \cdot V_{CC} \cdot f_{in} + I_{CC}/8$  (per bit).  $C_{PD}$  is used to determine the no-load dynamic power consumption;  $P_D = C_{PD} \cdot V_{CC}^2 \cdot f_{in} + I_{CC} \cdot V_{CC}$ .

## NOISE CHARACTERISTICS (Input $t_r = t_f = 3.0\text{ns}$ , $C_L = 50\text{pF}$ , $V_{CC} = 5.0\text{V}$ )

| Symbol    | Parameter                                | $T_A = 25^\circ\text{C}$ |       | Unit |
|-----------|------------------------------------------|--------------------------|-------|------|
|           |                                          | Typ                      | Max   |      |
| $V_{OLP}$ | Quiet Output Maximum Dynamic $V_{OL}$    | 0.6                      | 0.9   | V    |
| $V_{OLV}$ | Quiet Output Minimum Dynamic $V_{OL}$    | - 0.6                    | - 0.9 | V    |
| $V_{IHD}$ | Minimum High Level Dynamic Input Voltage |                          | 3.5   | V    |
| $V_{ILD}$ | Maximum Low Level Dynamic Input Voltage  |                          | 1.5   | V    |



# MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS



SCALE 1:1

SOIC-20 WB  
CASE 751D-05  
ISSUE H

DATE 22 APR 2015



## NOTES:

1. DIMENSIONS ARE IN MILLIMETERS.
2. INTERPRET DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994.
3. DIMENSIONS D AND E DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 PER SIDE.
5. DIMENSION B DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE PROTRUSION SHALL BE 0.13 TOTAL IN EXCESS OF B DIMENSION AT MAXIMUM MATERIAL CONDITION.

| DIM | MILLIMETERS |       |
|-----|-------------|-------|
|     | MIN         | MAX   |
| A   | 2.35        | 2.65  |
| A1  | 0.10        | 0.25  |
| b   | 0.35        | 0.49  |
| c   | 0.23        | 0.32  |
| D   | 12.65       | 12.95 |
| E   | 7.40        | 7.60  |
| e   | 1.27 BSC    |       |
| H   | 10.05       | 10.55 |
| h   | 0.25        | 0.75  |
| L   | 0.50        | 0.90  |
| θ   | 0°          | 7°    |

## GENERIC MARKING DIAGRAM\*



XXXXXX = Specific Device Code  
A = Assembly Location  
WL = Wafer Lot  
YY = Year  
WW = Work Week  
G = Pb-Free Package

## RECOMMENDED SOLDERING FOOTPRINT\*



DIMENSIONS: MILLIMETERS

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "▪", may or may not be present. Some products may not follow the Generic Marking.

|                  |             |                                                                                                                                                                                     |
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# MECHANICAL CASE OUTLINE

## PACKAGE DIMENSIONS

ON Semiconductor®

ON



SCALE 2:1

TSSOP-20 WB  
CASE 948E  
ISSUE D

DATE 17 FEB 2016



### NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSION A DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
4. DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.
5. DIMENSION K DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE K DIMENSION AT MAXIMUM MATERIAL CONDITION.
6. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
7. DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE -W-.

| DIM | MILLIMETERS |      | INCHES    |       |
|-----|-------------|------|-----------|-------|
|     | MIN         | MAX  | MIN       | MAX   |
| A   | 6.40        | 6.60 | 0.252     | 0.260 |
| B   | 4.30        | 4.50 | 0.169     | 0.177 |
| C   | ---         | 1.20 | ---       | 0.047 |
| D   | 0.05        | 0.15 | 0.002     | 0.006 |
| F   | 0.50        | 0.75 | 0.020     | 0.030 |
| G   | 0.65 BSC    |      | 0.026 BSC |       |
| H   | 0.27        | 0.37 | 0.011     | 0.015 |
| J   | 0.09        | 0.20 | 0.004     | 0.008 |
| J1  | 0.09        | 0.16 | 0.004     | 0.006 |
| K   | 0.19        | 0.30 | 0.007     | 0.012 |
| K1  | 0.19        | 0.25 | 0.007     | 0.010 |
| L   | 6.40 BSC    |      | 0.252 BSC |       |
| M   | 0°          | 8°   | 0°        | 8°    |

### GENERIC MARKING DIAGRAM\*



- A = Assembly Location
- L = Wafer Lot
- Y = Year
- W = Work Week
- = Pb-Free Package

(Note: Microdot may be in either location)

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "▪", may or may not be present.

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DESCRIPTION: TSSOP-20 WB

PAGE 1 OF 1

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